

DATA SHEET

CBT3384

10-bit bus switch with 5-bit output enables

Product data
Supersedes data of 2001 Mar 10
File under Integrated Circuits — ICL03

2001 Dec 20

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FEATURES

- 5 Ω switch connection between two ports
- TTL compatible control input and output levels
- See CBT3384 for CBT3384 with Schottky diode undershoot protection
- See CBT3384 for CBT3384 with level shifting diodes
- Latch-up is done to JESDEC Standard JESD78 which exceeds 100 mA
- ESD classification testing is done to JESDEC Standard JESD22. Protection exceeds 2000 V to HBM per method A114 and 1000 V CDM per method C101.

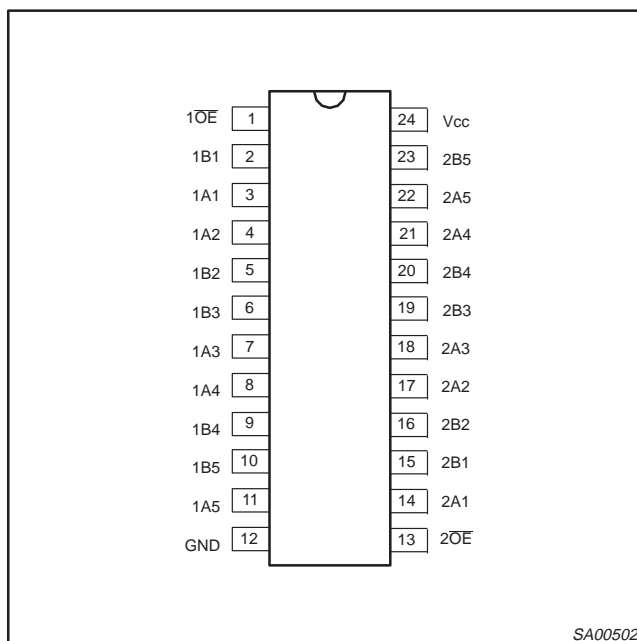
DESCRIPTION

The CBT3384 provides ten bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3384 device is organized as two 5-bit bus switches with separate output-enable (\overline{OE}) inputs. When \overline{OE} is LOW, the switch is on and port A is connected to B. When \overline{OE} is HIGH, the switch is open and high-impedance state exists between the two ports.

The CBT3384 is characterized for operation from -40 to $+85$ $^{\circ}\text{C}$.

PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 13	$1\overline{OE}$, $2\overline{OE}$	Output enables
3, 4, 7, 8, 11	1A1–1A5	Inputs
14, 17, 18, 21, 22	2A1–2A5	Inputs
2, 5, 6, 9, 10	1B1–1B5	Outputs
15, 16, 19, 20, 23	2B1–2B5	Outputs
12	GND	Ground (0 V)
24	V_{CC}	Positive supply voltage

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25$ $^{\circ}\text{C}$; GND = 0 V	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay An to Yn	$C_L = 50$ pF; $V_{CC} = 5$ V	250	ps
C_{IN}	Input capacitance	$V_I = 0$ V or V_{CC}	4	pF
C_{OUT}	Output capacitance	Outputs disabled; $V_O = 0$ V or V_{CC}	10	pF
I_{CCZ}	Total supply current	Outputs disabled; $V_{CC} = 5.5$ V	3	μA

ORDERING INFORMATION

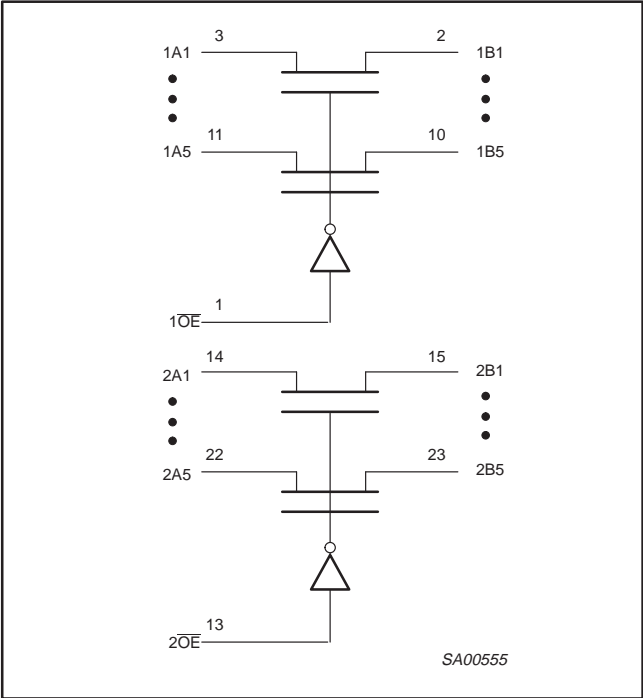
PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
24-Pin Plastic SO	-40 to $+85$ $^{\circ}\text{C}$	CBT3384D	SOT137-1
24-Pin Plastic SSOP	-40 to $+85$ $^{\circ}\text{C}$	CBT3384DB	SOT340-1
24-Pin Plastic SSOP (QSOP)	-40 to $+85$ $^{\circ}\text{C}$	CBT3384DK	SOT556-1
24-Pin Plastic TSSOP	-40 to $+85$ $^{\circ}\text{C}$	CBT3384PW	SOT355-1

Standard packing quantities and other packaging data is available at www.philipslogic.com/packaging.

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LOGIC SYMBOL



FUNCTION TABLE

INPUTS		OUTPUTS	
1OE	2OE	1A, 1B	2A, 2B
L	L	1A = 1B	2A = 2B
L	H	1A = 1B	Z
H	L	Z	2A = 2B
H	H	Z	Z

H = High voltage level
L = Low voltage level
Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		−0.5 to +7.0	V
I _{IK}	DC input diode current		−50	mA
V _I	DC input voltage ³		−1.2 to +7.0	V
I _{SW}	DC output diode current	V _O < 0	±128	mA
T _{stg}	Storage temperature range		−65 to +150	°C

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		Min	Max	
V _{CC}	DC supply voltage	4.5	5.5	V
V _{IH}	High-level input voltage	2.0	—	V
V _{IL}	Low-level Input voltage	—	0.8	V
T _{amb}	Operating free-air temperature range	−40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			T _{amb} = −40 to +85 °C			
			Min	Typ ¹	Max	
V _{IK}	Input clamp voltage	V _{CC} = 4.5 V; I _I = −18 mA	—	—	−1.2	V
I _I	Input leakage current	V _{CC} = 5.5 V; V _I = GND or 5.5 V	—	—	±1	μA
I _{CC}	Quiescent supply current ²	V _{CC} = 5.5 V; I _O = 0, V _I = V _{CC} or GND	—	—	3	μA
ΔI _{CC}	Additional supply current per input pin ²	V _{CC} = 5.5 V, one input at 3.4 V, other inputs at V _{CC} or GND	—	—	2.5	mA
C _I	Control pins	V _I = 3.0 V or 0	—	4	—	pF
C _{I(OFF)}	Port off capacitance	V _O = 3.0 V or 0, $\overline{\text{OE}}$ = V _{CC}	—	10	—	pF
r _{on} ³	On-resistance	V _{CC} = 4.5 V; V _I = 0 V; I _I = 64 mA	—	5	7	Ω
		V _{CC} = 4.5 V; V _I = 0 V; I _I = 30 mA	—	5	7	
		V _{CC} = 4.5 V; V _I = 2.4 V; I _I = −15 mA	—	10	15	
V _P	Pass voltage	V _I = V _{CC} = 5.0 V; I _O = −100 μA	3.4	3.6	3.9	V
I _{UCP}	Undershoot static current protection	V _{CC} = 5.0 V, I _B = 400 μA; $\overline{\text{OE}}$ = 5.0 V; V _B ≥ 3.0 V	—	8	—	mA

NOTES:

1. All typical values are at $V_{\text{CC}} = 5 \text{ V}$, $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$
2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.
3. Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

AC CHARACTERISTICS

GND = 0 V; t_{R} ; $C_{\text{L}} = 50 \text{ pF}$

SYMBOL	PARAMETER	FROM (INPUT)	TO (OUTPUT)	LIMITS		UNIT
				V _{CC} = +5.0 V ±0.5 V		
				Min	Max	
t _{pd}	Propagation delay ¹	A or B	B or A	—	.25	ns
t _{en}	Output enable time to High and Low level	OE	A or B	1.0	5.7	ns
t _{dis}	Output disable time from High and Low level	OE	A or B	1.0	5.2	ns

NOTE:

1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

SYMBOL	PARAMETER DESCRIPTION	LIMITS			UNIT
		T _{amb} = −40 to +85 °C V _{CC} = 5 V, ±0.5 V			
		MIN.	MEAN	MAX.	
t _{pd}	Propagation delay (see Note 1)	—	—	250	ps
t _{pZH}	Output enable time to High level	1.6	3.4	5.6	ns
t _{PHZ}	Output enable time from High level	1.7	3.3	5.5	ns
t _{pZL}	Output enable time to Low level	2.3	4	6	ns
t _{PLZ}	Output enable time from Low level	2.5	4.5	6.6	ns

NOTE:

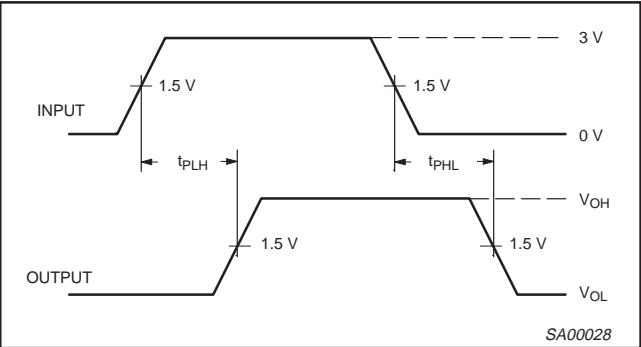
1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance); at +25 $^{\circ}\text{C}$.

10-bit bus switch with 5-bit output enables

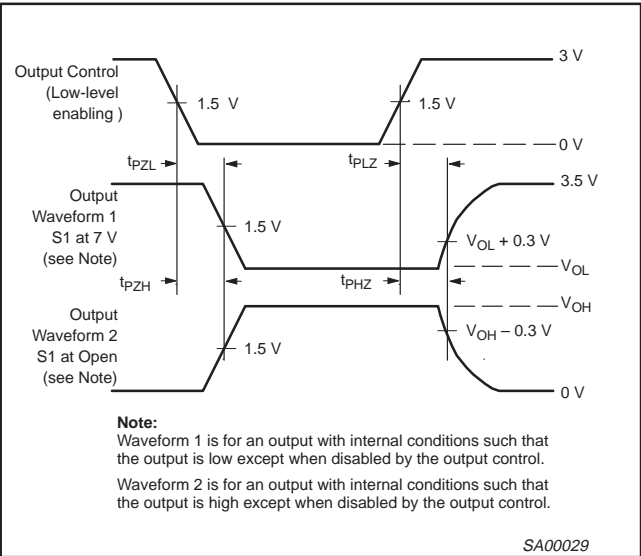
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AC WAVEFORMS

$V_M = 1.5\text{ V}$, $V_{IN} = \text{GND to } 3.0\text{ V}$



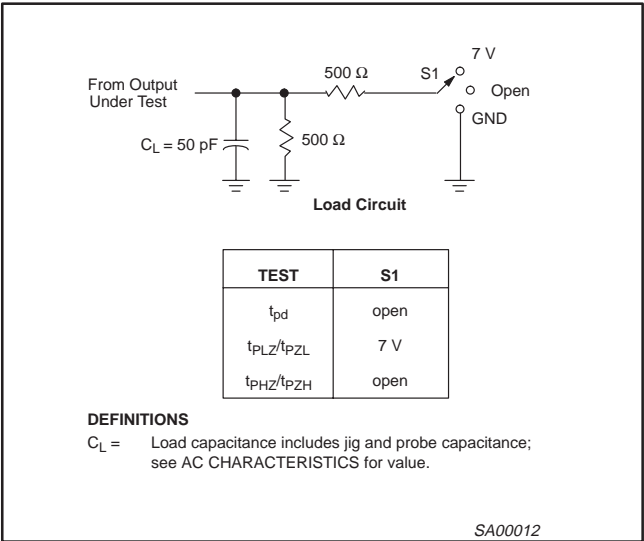
Waveform 1. Input (An) to Output (Yn) Propagation Delays



Note:
Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

Waveform 2. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORMS



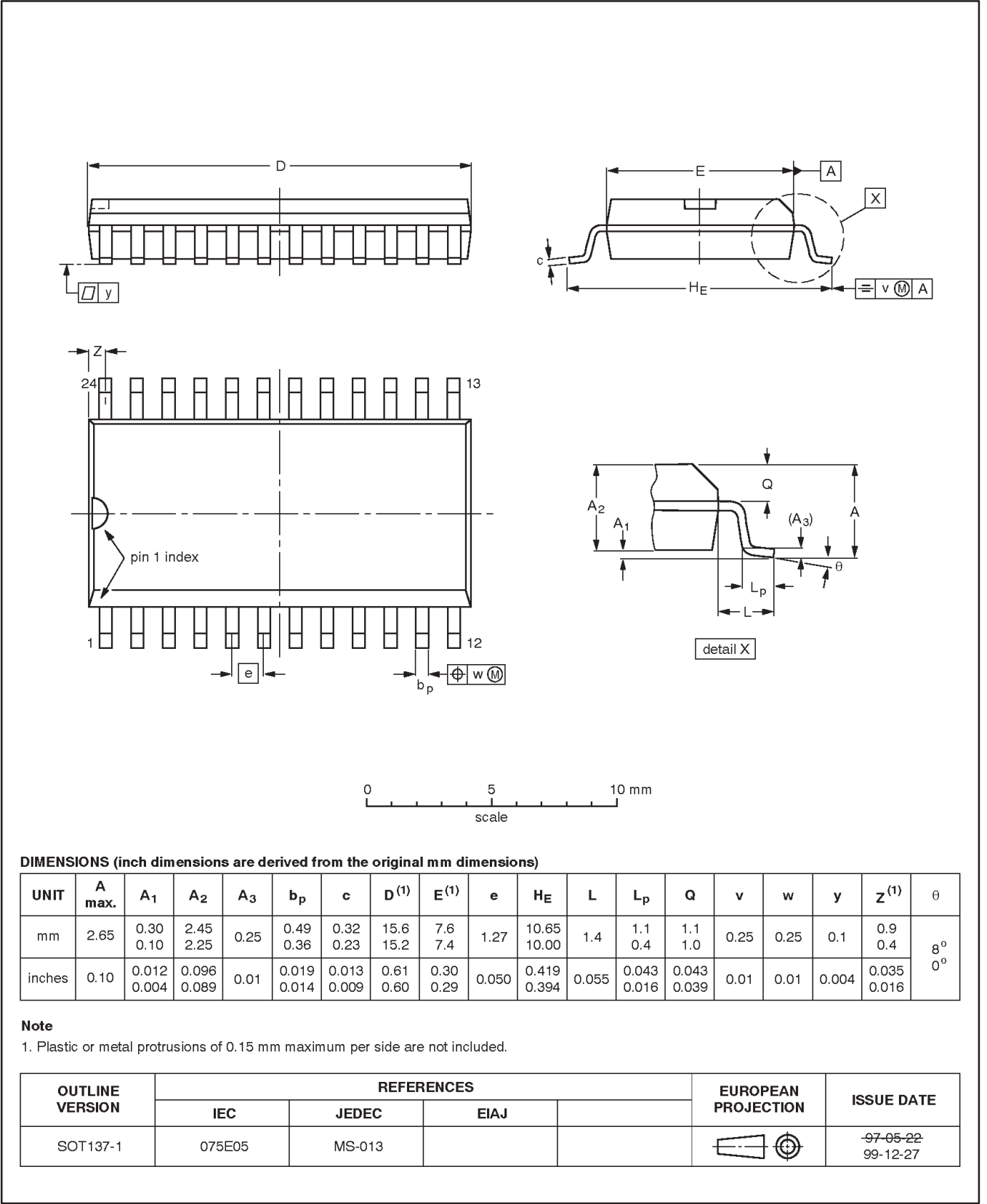
- NOTES:**
1. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 2. The outputs are measured one at a time with one transition per measurement.

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SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1

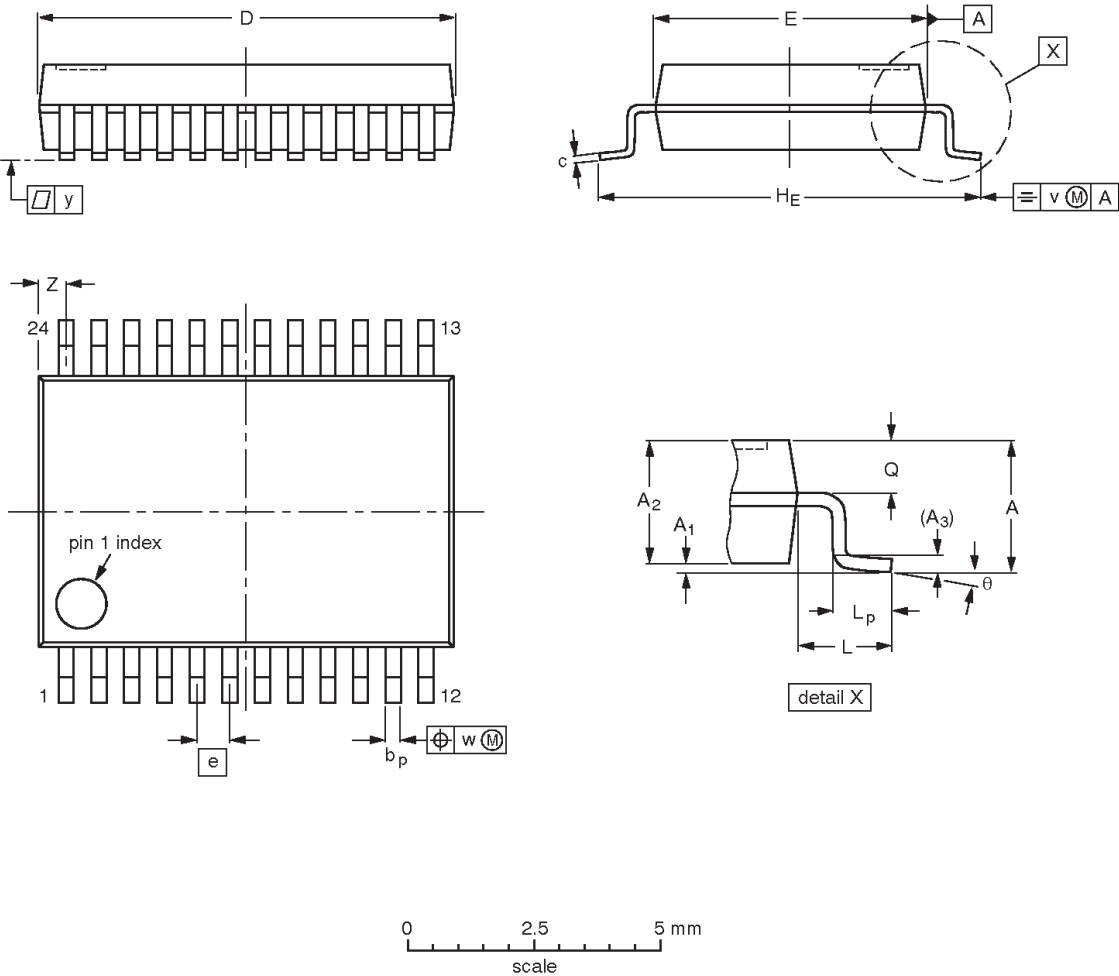


10-bit bus switch with 5-bit output enables

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SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	8.4 8.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.8 0.4	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

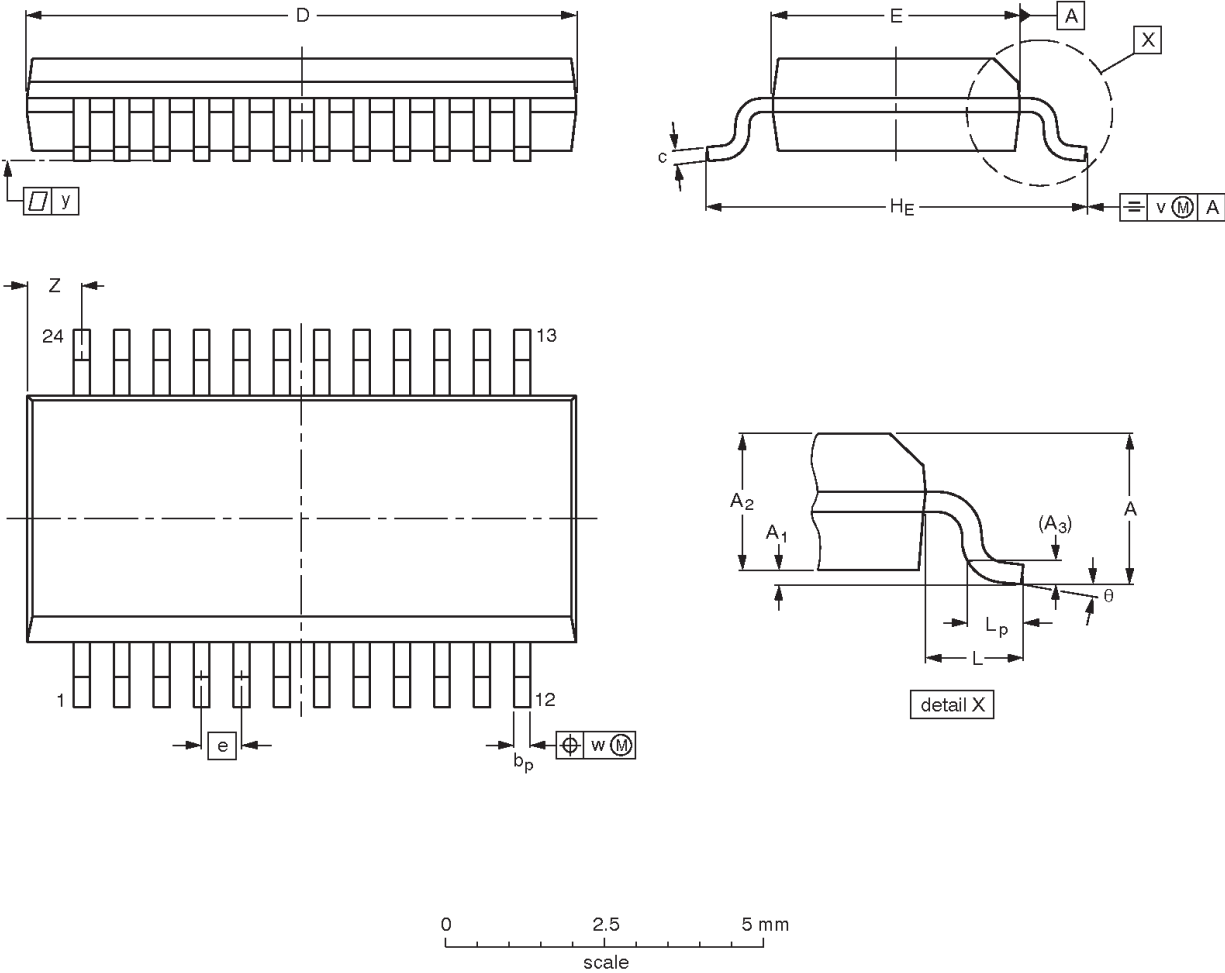
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT340-1		MO-150				95-02-04 99-12-27

10-bit bus switch with 5-bit output enables

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SSOP24: plastic shrink small outline package; 24 leads;
body width 3.9 mm; lead pitch 0.635 mm

SOT556-1



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	v	w	y	Z ⁽¹⁾	θ
mm	1.73	0.25 0.10	1.55 1.40	0.25	0.31 0.20	0.25 0.18	8.8 8.6	4.0 3.8	0.635	6.2 5.8	1.0	0.89 0.41	0.25	0.18	0.1	1.05 0.66	8° 0°
inches	0.068	0.0098 0.0040	0.061 0.055	0.010	0.012 0.008	0.0098 0.0075	0.344 0.337	0.157 0.150	0.025	0.244 0.228	0.041	0.035 0.016	0.010	0.007	0.004	0.040 0.026	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

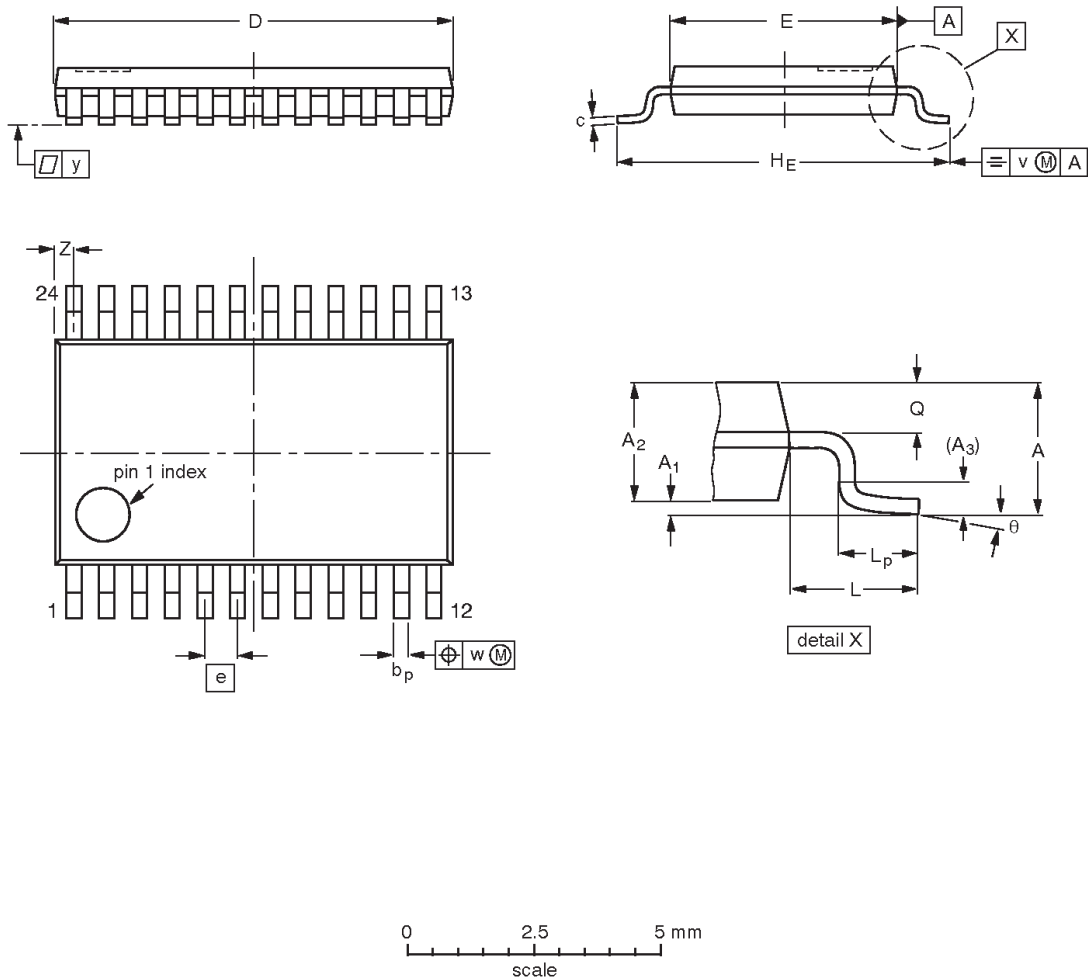
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT556-1		MO-137				99-05-05 99-12-27

10-bit bus switch with 5-bit output enables

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TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

- Notes**
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT355-1		MO-153				95-02-04 99-12-27

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Data sheet status

Data sheet status ^[1]	Product status ^[2]	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

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Date of release: 12-01

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Document order number:

9397 750 09247

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